

NOTES:

1.MATERIAL:

HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL94V_0,COLOR:BLACK.

CONTACT: COPPER ALLOYS.

COVER: COPPER ALLOYS OR STEEL.

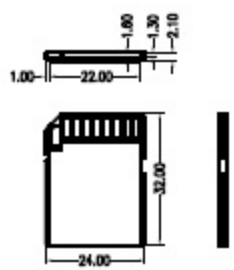
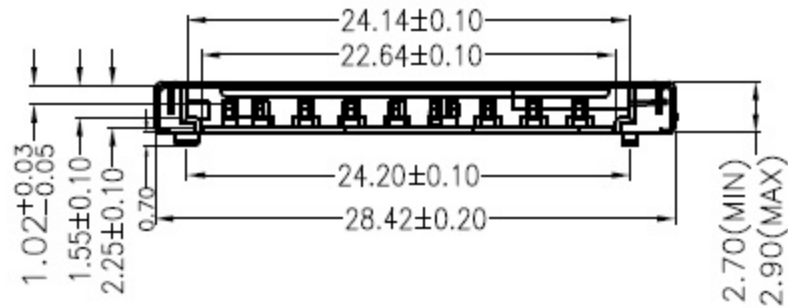
2.PLATING:

UNDERPLATE: NICKEL.

CONTACT AREA: GOLD OVER NICKEL.

SOLDER AREA: TIN OVER NICKEL.

3.MULTIMEDIA CARD COMPATIBLE



SD CARD

PART NO: SDPF1-EBS1-131X		MATERIAL:		RUI CHI	
LOT NO: X1XXX00110		FINSH:			
UNIT: MM	SIZE: A4	COLOR:			
TOLERANCES: X.X=±0.35 X.XX=±0.25 X.XXX=±0.15		GENERAL ANGLE: X.X=±5.0° X.XX=±3.0°		SD-03 push fix	
DR: 杨凯 08/26/09		CHK:		DWG NO: FP-090015	REV: B/3
APP:		SCALE: 1:1		SHEET: 1 OF 3	